Complementary Silicon Plastic Power Transistors

Designed for use in general purpose amplifier and switching applications.

Features

• Collector-Emitter Saturation Voltage -

 $V_{CE(sat)} = 1.2 \text{ Vdc (Max)} @ I_C = 3.0 \text{ Adc}$

• Collector-Emitter Sustaining Voltage -

V_{CEO(sus)} = 40 Vdc (Min) – TIP31, TIP32 = 60 Vdc (Min) – TIP31A, TIP32A = 80 Vdc (Min) – TIP31B, TIP32B = 100 Vdc (Min) – TIP31C, TIP32C

• High Current Gain – Bandwidth Product

 $f_T = 3.0 \text{ MHz (Min)} @ I_C = 500 \text{ mAdc}$

- Compact TO-220 AB Package
- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage TIP31, TIP32 TIP31A, TIP32A TIP31B, TIP32B TIP31C, TIP32C	V _{CEO}	40 60 80 100	Vdc
Collector-Base Voltage TIP31, TIP32 TIP31A, TIP32A TIP31B, TIP32B TIP31C, TIP32C	V _{CB}	40 60 80 100	Vdc
Emitter-Base Voltage	V _{EB}	5.0	Vdc
Collector Current Continuous Peak	I _C	3.0 5.0	Adc
Base Current	Ι _Β	1.0	Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	40 0.32	W W/°C
Total Power Dissipation @ T _A = 25°C Derate above 25°C	P _D	2.0 0.016	W W/°C
Unclamped Inductive Load Energy (Note 1)	E	32	mJ
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

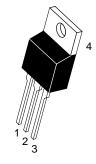
1. $I_C = 1.8 \text{ Å}$, L = 20 mH, P.R.F. = 10 Hz, $V_{CC} = 10 \text{ V}$, $R_{BE} = 100 \Omega$



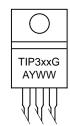
ON Semiconductor®

http://onsemi.com

3 AMPERE POWER TRANSISTORS COMPLEMENTARY SILICON 40-60-80-100 VOLTS, 40 WATTS



MARKING DIAGRAM



TO-220AB CASE 221A STYLE 1

TIP3xx = Device Code xx = 1, 1A, 1B, 1C, 2, 2A, 2B, 2C, A = Assembly Location Y = Year

Y = Year WW = Work Week G Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{ heta JA}$	62.5	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	3.125	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic			Min	Max	Unit
OFF CHARACTERISTICS			•		1
Collector–Emitter Sustaining Voltage (Note 2) $(I_C = 30 \text{ mAdc}, I_B = 0)$	TIP31, TIP32 TIP31A, TIP32A TIP31B, TIP32B TIP31C, TIP32C	V _{CEO(sus)}	40 60 80 100	- - -	Vdc
Collector Cutoff Current ($V_{CE} = 30 \text{ Vdc}$, $I_B = 0$) ($V_{CE} = 60 \text{ Vdc}$, $I_B = 0$)	TIP31, TIP32, TIP31A, TIP32A TIP31B, TIP31C, TIP32B, TIP32C	I _{CEO}		0.3 0.3	mAdc
$ \begin{aligned} &\text{Collector Cutoff Current} \\ &(\text{V}_{\text{CE}} = 40 \text{ Vdc}, \text{V}_{\text{EB}} = 0) \\ &(\text{V}_{\text{CE}} = 60 \text{ Vdc}, \text{V}_{\text{EB}} = 0) \\ &(\text{V}_{\text{CE}} = 80 \text{ Vdc}, \text{V}_{\text{EB}} = 0) \\ &(\text{V}_{\text{CE}} = 100 \text{ Vdc}, \text{V}_{\text{EB}} = 0) \end{aligned} $	TIP31, TIP32 TIP31A, TIP32A TIP31B, TIP32B TIP31C, TIP32C	I _{CES}	- - -	200 200 200 200	μAdc
Emitter Cutoff Current ($V_{BE} = 5.0 \text{ Vdc}, I_{C} = 0$)		I _{EBO}	_	1.0	mAdc
ON CHARACTERISTICS (Note 2)					
DC Current Gain ($I_C = 1.0$ Adc, $V_{CE} = 4.0$ Vdc) ($I_C = 3.0$ Adc, $V_{CE} = 4.0$ Vdc)		h _{FE}	25 10	- 50	_
Collector–Emitter Saturation Voltage (I _C = 3.0 Adc, I _B = 375 mAdc)		V _{CE(sat)}	_	1.2	Vdc
Base–Emitter On Voltage (I _C = 3.0 Adc, V _{CE} = 4.0 Vdc)		V _{BE(on)}	_	1.8	Vdc
DYNAMIC CHARACTERISTICS					
Current-Gain – Bandwidth Product (I _C = 500 mAdc, V _{CE} = 10 Vdc, f _{test} = 1.0 MHz)		f _T	3.0	_	MHz
Small–Signal Current Gain (I _C = 0.5 Adc, V _{CE} = 10 Vdc, f = 1.0 kHz)		h _{fe}	20		_

^{2.} Pulse Test: Pulse Width $\leq 300 \,\mu\text{s}$, Duty Cycle $\leq 2.0\%$.

ORDERING INFORMATION

Device	Package	Shipping
TIP31	TO-220	50 Units / Rail
TIP31G	TO-220 (Pb-Free)	50 Units / Rail
TIP31A	TO-220	50 Units / Rail
TIP31AG	TO-220 (Pb-Free)	50 Units / Rail
TIP31B	TO-220	50 Units / Rail
TIP31BG	TO-220 (Pb-Free)	50 Units / Rail
TIP31C	TO-220	50 Units / Rail
TIP31CG	TO-220 (Pb-Free)	50 Units / Rail
TIP32	TO-220	50 Units / Rail
TIP32G	TO-220 (Pb-Free)	50 Units / Rail
TIP32A	TO-220	50 Units / Rail
TIP32AG	TO-220 (Pb-Free)	50 Units / Rail
TIP32B	TO-220	50 Units / Rail
TIP32BG	TO-220 (Pb-Free)	50 Units / Rail
TIP32C	TO-220	50 Units / Rail
TIP32CG	TO-220 (Pb-Free)	50 Units / Rail

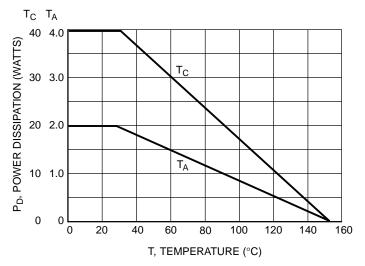


Figure 1. Power Derating

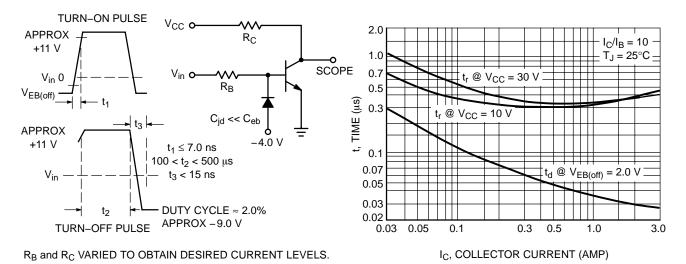


Figure 2. Switching Time Equivalent Circuit

Figure 3. Turn-On Time

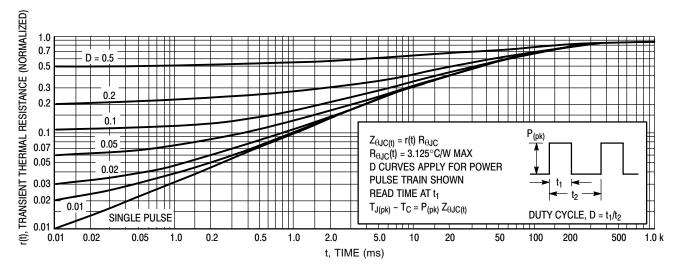


Figure 4. Thermal Response

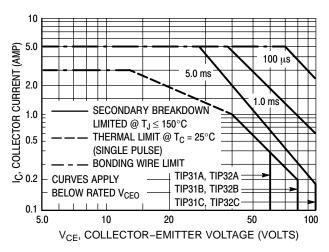


Figure 5. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150^{\circ}\text{C}$; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150^{\circ}\text{C}$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

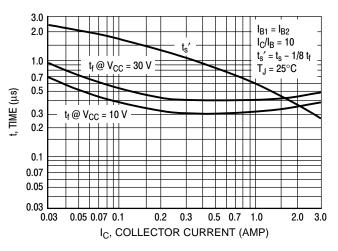


Figure 6. Turn-Off Time

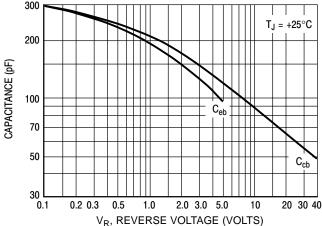


Figure 7. Capacitance

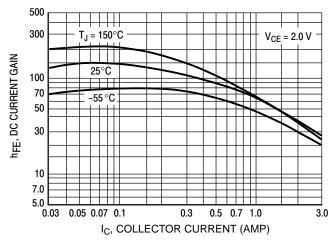


Figure 8. DC Current Gain

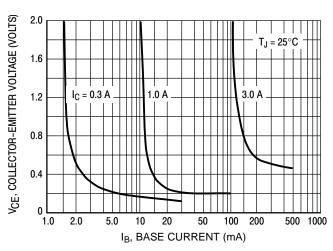


Figure 9. Collector Saturation Region

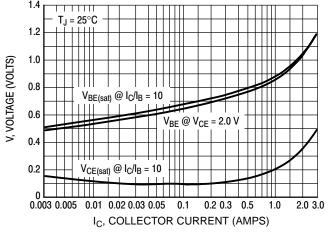


Figure 10. "On" Voltages

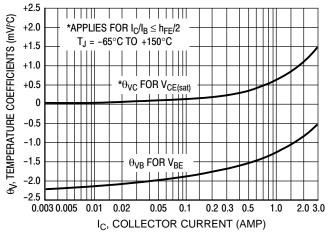


Figure 11. Temperature Coefficients

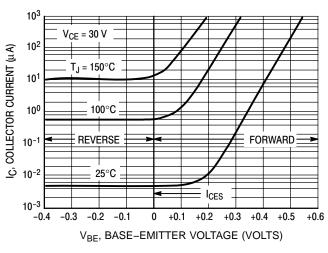


Figure 12. Collector Cut-Off Region

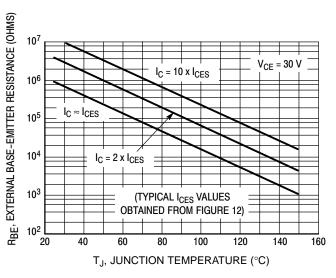
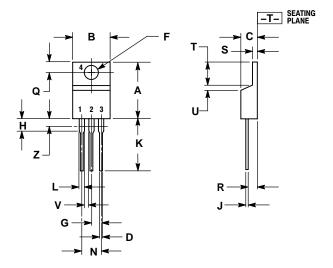


Figure 13. Effects of Base-Emitter Resistance

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AA**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	INCHES MILLIMETER		IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

STYLE 1: PIN 1. BASE

COLLECTOR 2. **EMITTER**

COLLECTOR

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